



Welcome to [E-XFL.COM](#)

What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	F ² MC-16LX
Core Size	16-Bit
Speed	16MHz
Connectivity	CANbus, EBI/EMI, SCI, Serial I/O, UART/USART
Peripherals	POR, WDT
Number of I/O	81
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	6K x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	A/D 8x8/10b
Oscillator Type	External
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	100-BQFP
Supplier Device Package	100-QFP (14x20)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb90f543gspf-gs-bi24

3. Pin Description

Pin No.		Pin name	Circuit type	Function
LQFP ²	QFP ¹			
80 81	82 83	X0 X1	A (Oscillation)	High speed crystal oscillator input pins
78	80	X0A	A (Oscillation)	Low speed crystal oscillator input pins. For the one clock system parts, perform external pull-down processing.
77	79	X1A		Low speed crystal oscillator input pins. For the one clock system parts, leave it open.
75	77	$\overline{\text{RST}}$	B	External reset request input pin
50	52	$\overline{\text{HST}}$	C	Hardware standby input pin
83 to 90	85 to 92	P00 to P07	I	General I/O port with programmable pullup. This function is enabled in the single-chip mode.
		AD00 to AD07		I/O pins for 8 lower bits of the external address/data bus. This function is enabled when the external bus is enabled.
91 to 98	93 to 100	P10 to P17	I	General I/O port with programmable pullup. This function is enabled in the single-chip mode.
		AD08 to AD15		I/O pins for 8 higher bits of the external address/data bus. This function is enabled when the external bus is enabled.
99 to 6	1 to 8	P20 to P27	I	General I/O port with programmable pullup. In external bus mode, this function is valid when the corresponding bits in the external address output control resister (HACR) are set to "1".
		A16 to A23		8-bit I/O pins for A16 to A23 at the external address/data bus. In external bus mode, this function is valid when the corresponding bits in the external address output control resister (HACR) are set to "0".
7	9	P30	I	General I/O port with programmable pullup. This function is enabled in the single-chip mode.
		ALE		Address latch enable output pin. This function is enabled when the external bus is enabled.
8	10	P31	I	General I/O port with programmable pullup. This function is enabled in the single-chip mode.
		$\overline{\text{RD}}$		Read strobe output pin for the data bus. This function is enabled when the external bus is enabled.
10	12	P32	I	General I/O port with programmable pullup. This function is enabled in the single-chip mode or when the $\overline{\text{WR}}/\overline{\text{WRL}}$ pin output is disabled.
		$\overline{\text{WRL}}$		Write strobe output pin for the data bus. This function is enabled when both the external bus and the $\overline{\text{WR}}/\overline{\text{WRL}}$ pin output are enabled. $\overline{\text{WRL}}$ is write-strobe output pin for the lower 8 bits of the data bus in 16-bit access.
		$\overline{\text{WR}}$		$\overline{\text{WR}}$ is write-strobe output pin for the 8 bits of the data bus in 8-bit access.

(Continued)

Pin No.		Pin name	Circuit type	Function
LQFP ²	QFP ¹			
11	13	P33	I	General I/O port with programmable pullup. This function is enabled in the single-chip mode, external bus 8-bit mode or when WRH pin output is disabled.
		$\overline{\text{WRH}}$		Write strobe output pin for the 8 higher bits of the data bus. This function is enabled when the external bus is enabled, when the external bus 16-bit mode is selected, and when the WRH output pin is enabled.
12	14	P34	I	General I/O port with programmable pullup. This function is enabled in the single-chip mode or when the hold function is disabled.
		HRQ		Hold request input pin. This function is enabled when both the external bus and the hold functions are enabled.
13	15	P35	I	General I/O port with programmable pullup. This function is enabled in the single-chip mode or when the hold function is disabled.
		$\overline{\text{HAK}}$		Hold acknowledge output pin. This function is enabled when both the external bus and the hold functions are enabled.
14	16	P36	I	General I/O port with programmable pullup. This function is enabled in the single-chip mode or when the external ready function is disabled.
		RDY		Ready input pin. This function is enabled when both the external bus and the external ready functions are enabled.
15	17	P37	H	General I/O port with programmable pullup. This function is enabled in the single-chip mode or when the CLK output is disabled.
		CLK		CLK output pin. This function is enabled when both the external bus and CLK outputs are enabled.
16	18	P40	G	General I/O port. This function is enabled when UART0 disables the serial data output.
		SOT0		Serial data output pin for UART0. This function is enabled when UART0 enables the serial data output.
17	19	P41	G	General I/O port. This function is enabled when UART0 disables serial clock output.
		SCK0		Serial clock I/O pin for UART0. This function is enabled when UART0 enables the serial clock output.
18	20	P42	G	General I/O port. This function is always enabled.
		SIN0		Serial data input pin for UART0. Set the corresponding Port Direction Register to input if this function is used.
19	21	P43	G	General I/O port. This function is always enabled.
		SIN1		Serial data input pin for UART1. Set the corresponding Port Direction Register to input if this function is used.

(Continued)

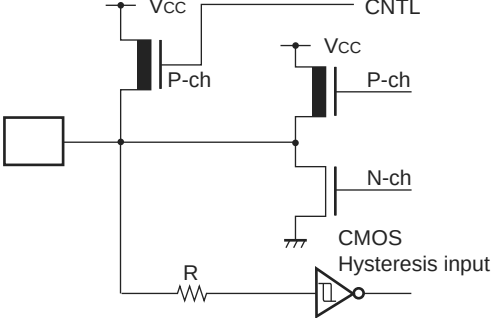
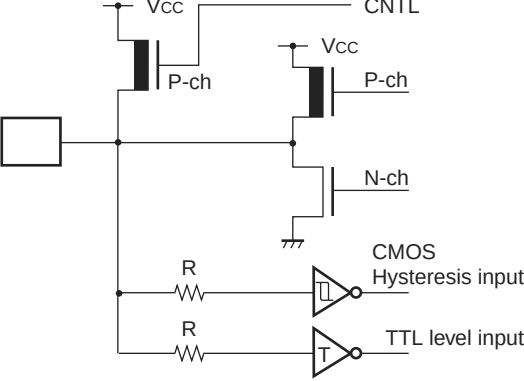
(Continued)

Pin No.		Pin name	Circuit type	Function
LQFP*2	QFP*1			
72	74	P95	D	General I/O port. This function is always enabled.
		RX0		RX input pin for CAN0 Interface. When the CAN function is used, output from the other functions must be stopped.
73	75	P96	D	General I/O port. This function is enabled when CAN1 disables the output.
		TX1		TX output pin for CAN1. This function is enabled when CAN1 enables the output (only MB90540G series) .
74	76	P97	D	General I/O port. This function is always enabled.
		RX1		RX input pin for CAN1 Interface. When the CAN function is used, output from the other functions must be stopped (only MB90540G series) .
76	78	PA0	D	General I/O port. This function is always enabled.
32	34	AV _{CC}	Power supply	Power supply pin for the A/D Converter. This power supply must be turned on or off while a voltage higher than or equal to AV _{CC} is applied to V _{CC} .
35	37	AV _{SS}	Power supply	Power supply pin for the A/D Converter.
33	35	AVRH	Power supply	External reference voltage input pin for the A/D Converter. This power supply must be turned on or off while a voltage higher than or equal to AVRH is applied to AV _{CC} .
34	36	AVRL	Power supply	External reference voltage input pin for the A/D Converter.
47, 48	49, 50	MD0, MD1	C	Input pins for specifying the operating mode. The pins must be directly connected to V _{CC} or V _{SS} .
49	51	MD2	F	Input pin for specifying the operating mode. The pin must be directly connected to V _{CC} or V _{SS} .
25	27	C	—	Power supply stabilization capacitor pin. It should be connected externally to an 0.1 μF ceramic capacitor.
21, 82	23, 84	V _{CC}	Power supply	Input pin for power supply (5.0 V) .
9, 40, 79	11, 42, 81	V _{SS}	Power supply	Input pin for power supply (0.0 V) .

*1 : FPT-100P-M06

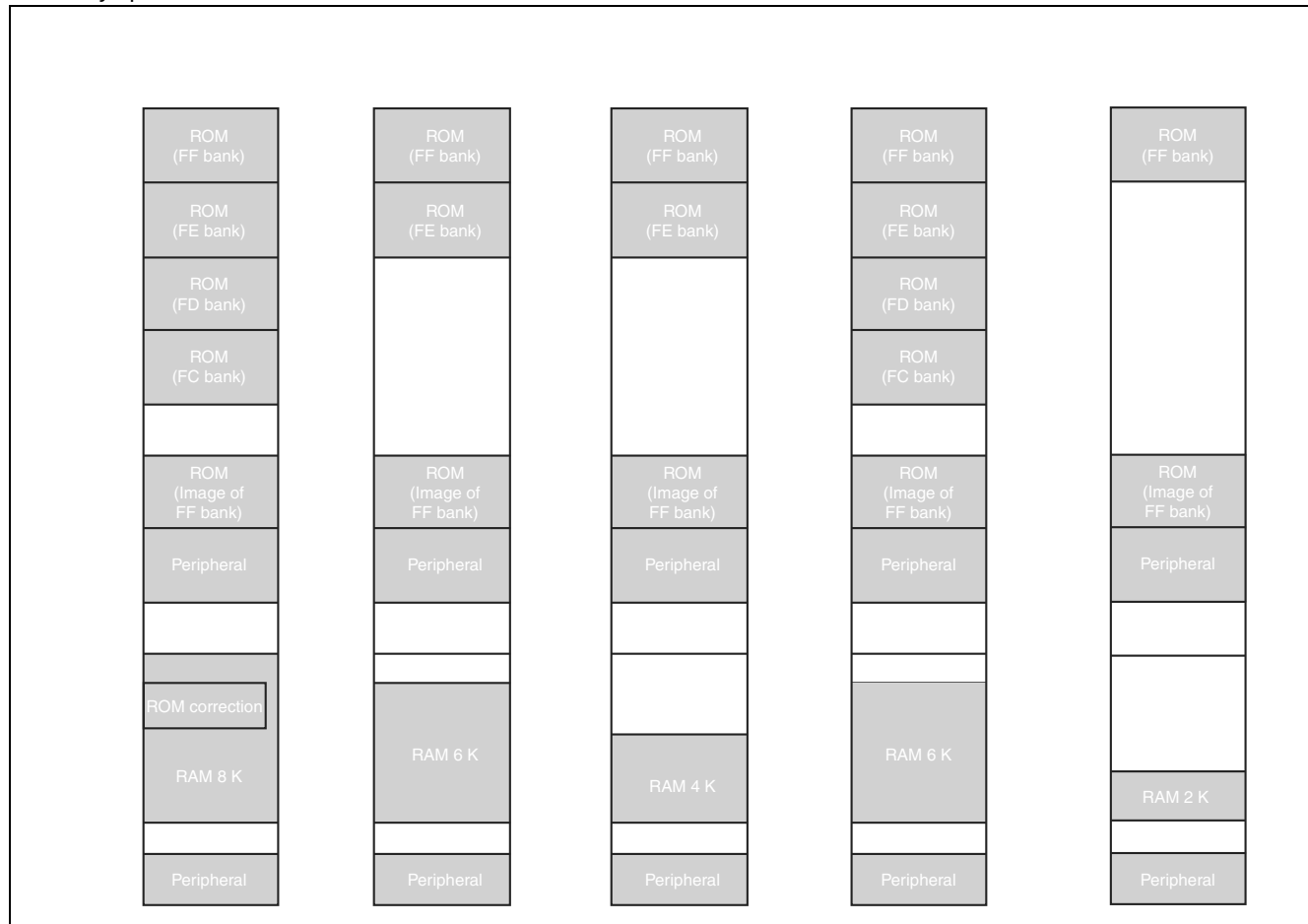
*2 : FPT-100P-M20

(Continued)

Circuit type	Diagram	Remarks
H		■ CMOS level output ■ CMOS Hysteresis input ■ Programmable pull-up resistor : 50 kΩ approx.
I		■ CMOS level output ■ CMOS Hysteresis input ■ TTL level input (Flash devices in Flash writer mode only) ■ Programmable pullup resistor : 50 kΩ approx.

7. Memory Map

The memory space of the MB90540G/545G Series is shown below.



Note : The high-order portion of bank 00 gives the image of the FF bank ROM to make the small model of the C compiler effective. Since the low-order 16 bits address are the same, the table in ROM can be referenced without using the “far” specification in the pointer declaration.

For example, an attempt to access 00C000_H accesses the value at FFC000_H in ROM. The ROM area in bank FF exceeds 48 Kbytes, and its entire image cannot be shown in bank 00. The image between FF4000_H and FFFFFFF_H is visible in bank 00, while the image between FF0000_H and FF3FFF_H is visible only in bank FF.

Address	Register	Abbreviation	Access	Resource name	Initial value
24 _H	Serial mode register 1	SMR1	R/W	UART1	0 0 0 0 0 0 0 0 _B
25 _H	Serial control register 1	SCR1	R/W		0 0 0 0 0 1 0 0 _B
26 _H	Serial input data register 1/ Serial output data register 1	SIDR1/SODR1	R/W		XXXXXXXX _B
27 _H	Serial status register 1	SSR1	R/W		0 0 0 0 1 _ 0 0 _B
28 _H	UART1 prescaler control register	CDCR	R/W		0 _ _ 1 1 1 1 _B
29 _H	Serial Edge select register	SES1	R/W		_ _ _ _ _ 0 _B
2A _H	Prohibited				
2B _H	Serial I/O prescaler	SCDCR	R/W	Extended I/O Serial Interface	0 _ _ 1 1 1 1 _B
2C _H	Serial mode control register	SMCS	R/W		_ _ _ 0 0 0 0 _B
2D _H	Serial mode control register	SMCS	R/W		0 0 0 0 0 1 0 0 _B
2E _H	Serial data register	SDR	R/W		XXXXXXXX _B
2F _H	Serial Edge select register	SES2	R/W		_ _ _ _ _ 0 _B
30 _H	External interrupt enable register	ENIR	R/W	External Interrupt	0 0 0 0 0 0 0 0 _B
31 _H	External interrupt request register	EIRR	R/W		XXXXXXXX _B
32 _H	External interrupt level register	ELVR	R/W		0 0 0 0 0 0 0 0 _B
33 _H	External interrupt level register	ELVR	R/W		0 0 0 0 0 0 0 0 _B
34 _H	A/D control status register 0	ADCS0	R/W	A/D Converter	0 0 0 0 0 0 0 0 _B
35 _H	A/D control status register 1	ADCS1	R/W		0 0 0 0 0 0 0 0 _B
36 _H	A/D data register 0	ADCR0	R		XXXXXXXX _B
37 _H	A/D data register 1	ADCR1	R/W		0 0 0 0 1 _ XX _B
38 _H	PPG0 operation mode control register	PPGC0	R/W	16-bit Programmable Pulse Generator 0/1	0 _ 0 0 _ _ 1 _B
39 _H	PPG1 operation mode control register	PPGC1	R/W		0 _ 0 0 0 0 1 _B
3A _H	PPG0/1 clock selection register	PPG01	R/W		0 0 0 0 0 _ _ _B
3B _H	Prohibited				
3C _H	PPG2 operation mode control register	PPGC2	R/W	16-bit Programmable Pulse Generator 2/3	0 _ 0 0 _ _ 1 _B
3D _H	PPG3 operation mode control register	PPGC3	R/W		0 _ 0 0 0 0 1 _B
3E _H	PPG2/3 Clock Selection Register	PPG23	R/W		0 0 0 0 0 _ _ _B
3F _H	Prohibited				
40 _H	PPG4 operation mode control register	PPGC4	R/W	16-bit Programmable Pulse Generator 4/5	0 _ 0 0 _ _ 1 _B
41 _H	PPG5 operation mode control register	PPGC5	R/W		0 _ 0 0 0 0 1 _B
42 _H	PPG4/5 clock selection register	PPG45	R/W		0 0 0 0 0 _ _ _B
43 _H	Prohibited				
44 _H	PPG6 operation mode control register	PPGC6	R/W	16-bit Programmable Pulse Generator 6/7	0 _ 0 0 _ _ 1 _B
45 _H	PPG7 operation mode control register	PPGC7	R/W		0 _ 0 0 0 0 1 _B
46 _H	PPG6/7 clock selection register	PPG67	R/W		0 0 0 0 0 _ _ _B

(Continued)

(Continued)

Address	Register	Abbreviation	Access	Resource name	Initial value
3928 _H	Output Compare Register 0	OCCP0	R/W	Output Compare 0/1	XXXXXXXX _B
3929 _H	Output Compare Register 0	OCCP0	R/W		XXXXXXXX _B
392A _H	Output Compare Register 1	OCCP1	R/W		XXXXXXXX _B
392B _H	Output Compare Register 1	OCCP1	R/W		XXXXXXXX _B
392C _H	Output Compare Register 2	OCCP2	R/W	Output Compare 2/3	XXXXXXXX _B
392D _H	Output Compare Register 2	OCCP2	R/W		XXXXXXXX _B
392E _H	Output Compare Register 3	OCCP3	R/W		XXXXXXXX _B
392F _H	Output Compare Register 3	OCCP3	R/W		XXXXXXXX _B
3930 _H to 39FF _H	Reserved				
3A00 _H to 3AFF _H	Reserved for CAN 0 Interface.				
3B00 _H to 3BFF _H	Reserved for CAN 0 Interface.				
3C00 _H to 3CFF _H	Reserved for CAN 1 Interface.				
3D00 _H to 3DFF _H	Reserved for CAN 1 Interface.				
3E00 _H to 3FFF _H	Reserved				

■ Read/write notation

R/W : Reading and writing permitted
R : Read-only
W : Write-only

■ Initial value notation

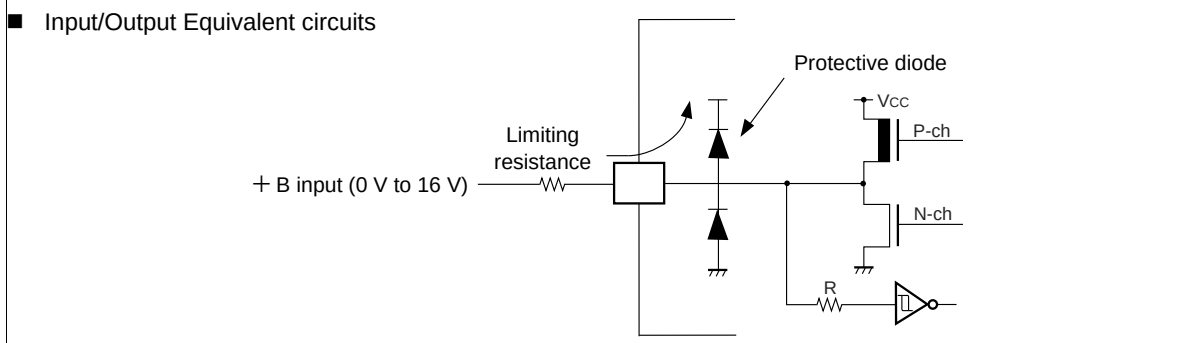
0 : Initial value is "0".
1 : Initial value is "1".
X : Initial value is undefined.
— : Initial value is unused.

Note: Any write access to reserved addresses in I/O map should not be performed. A read access to reserved addresses results in reading "X".

(Continued)

Address		Register	Abbreviation	Access	Initial Value
CAN0	CAN1				
003A3C _H	003C3C _H	ID register 7	IDR7	R/W	XXXXXXXX XXXXXXXX _B
003A3D _H	003C3D _H				
003A3E _H	003C3E _H				XXXXX--- XXXXXXXX _B
003A3F _H	003C3F _H				
003A40 _H	003C40 _H	ID register 8	IDR8	R/W	XXXXXXXX XXXXXXXX _B
003A41 _H	003C41 _H				
003A42 _H	003C42 _H				XXXXX--- XXXXXXXX _B
003A43 _H	003C43 _H				
003A44 _H	003C44 _H	ID register 9	IDR9	R/W	XXXXXXXX XXXXXXXX _B
003A45 _H	003C45 _H				
003A46 _H	003C46 _H				XXXXX--- XXXXXXXX _B
003A47 _H	003C47 _H				
003A48 _H	003C48 _H	ID register 10	IDR10	R/W	XXXXXXXX XXXXXXXX _B
003A49 _H	003C49 _H				
003A4A _H	003C4A _H				XXXXX--- XXXXXXXX _B
003A4B _H	003C4B _H				
003A4C _H	003C4C _H	ID register 11	IDR11	R/W	XXXXXXXX XXXXXXXX _B
003A4D _H	003C4D _H				
003A4E _H	003C4E _H				XXXXX--- XXXXXXXX _B
003A4F _H	003C4F _H				
003A50 _H	003C50 _H	ID register 12	IDR12	R/W	XXXXXXXX XXXXXXXX _B
003A51 _H	003C51 _H				
003A52 _H	003C52 _H				XXXXX--- XXXXXXXX _B
003A53 _H	003C53 _H				
003A54 _H	003C54 _H	ID register 13	IDR13	R/W	XXXXXXXX XXXXXXXX _B
003A55 _H	003C55 _H				
003A56 _H	003C56 _H				XXXXX--- XXXXXXXX _B
003A57 _H	003C57 _H				
003A58 _H	003C58 _H	ID register 14	IDR14	R/W	XXXXXXXX XXXXXXXX _B
003A59 _H	003C59 _H				
003A5A _H	003C5A _H				XXXXX--- XXXXXXXX _B
003A5B _H	003C5B _H				
003A5C _H	003C5C _H	ID register 15	IDR15	R/W	XXXXXXXX XXXXXXXX _B
003A5D _H	003C5D _H				
003A5E _H	003C5E _H				XXXXX--- XXXXXXXX _B
003A5F _H	003C5F _H				

- Note that analog system input/output pins other than the A/D input pins (LCD drive pins, comparator input pins, etc.) cannot accept + B signal input.
- Sample recommended circuits :



WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

11.2 Recommended Conditions

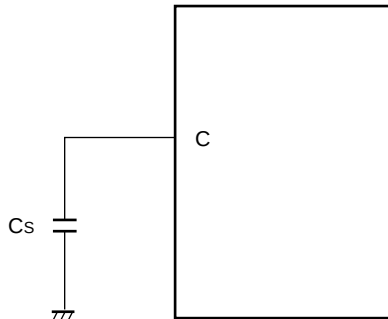
($V_{SS} = AV_{SS} = 0.0\text{ V}$)

Parameter	Symbol	Value			Units	Remarks
		Min	Typ	Max		
Power supply voltage	V_{CC}, AV_{CC}	4.5	5.0	5.5	V	Under normal operation : Other than MB90F548GL(S)/543G(S)/547G(S)/548G(S)
						Under normal operation when A/D converter is used : MB90F548GL(S)/543G(S)/547G(S)/548G(S)
		3.5	5.0	5.5	V	Under normal operation when A/D converter is not used : MB90F548GL(S)/543G(S)/547G(S)/548G(S)
		3.0	—	5.5	V	Maintain RAM data in stop mode
Smooth capacitor	C_S	0.022	0.1	1.0	μF	*
Operating temperature	T_A	−40	—	+105	°C	

*: Use a ceramic capacitor or a capacitor of better 4. AC characteristics. The bypass capacitor should be greater than this capacitor.

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges. Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure. No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

■ C Pin Connection Diagram



11.3 DC Characteristics

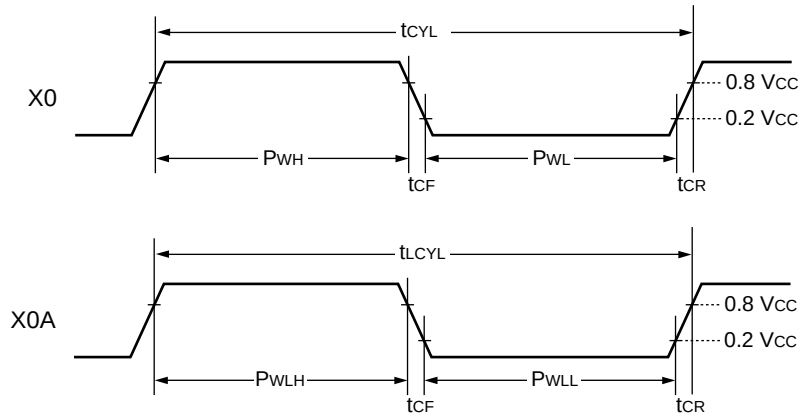
(MB90543G(S)/547G(S)/548G(S)/F548GL(S): $V_{CC} = 3.5 \text{ V to } 5.5 \text{ V}$, $V_{SS} = AV_{SS} = 0.0 \text{ V}$, $T_A = -40 \text{ }^{\circ}\text{C to } +105 \text{ }^{\circ}\text{C}$)

(Other than MB90543G(S)/547G(S)/548G(S)/F548GL(S): $V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0.0 \text{ V}$, $T_A = -40 \text{ }^{\circ}\text{C to } +105 \text{ }^{\circ}\text{C}$)

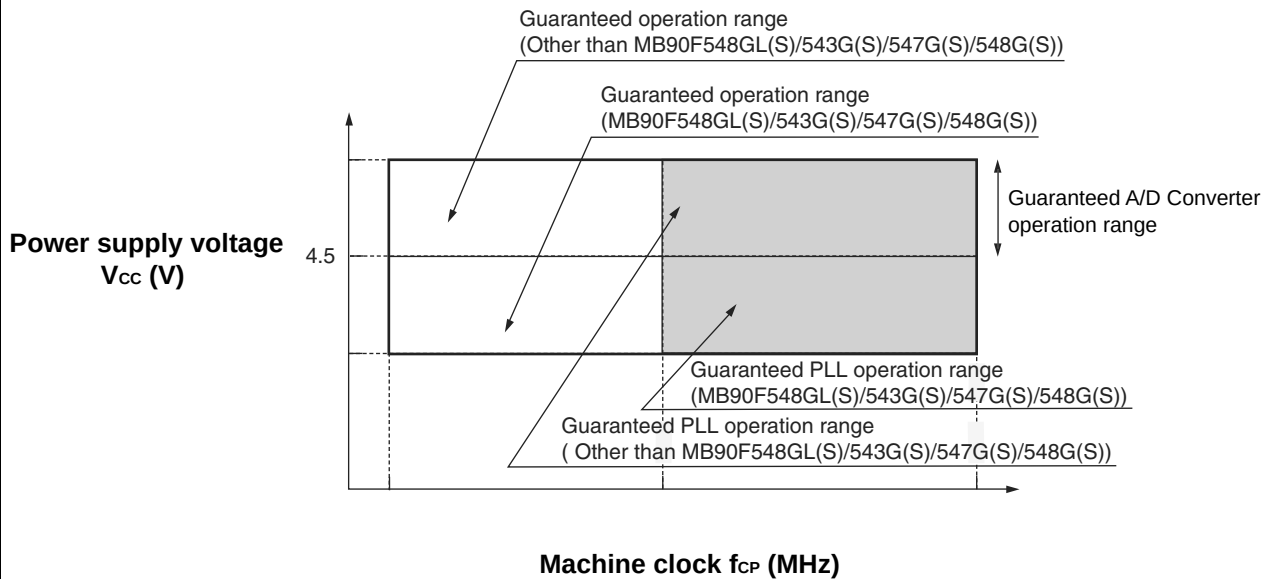
Parameter	Symbol	Pin name	Condition	Value			Units	Remarks
				Min	Typ	Max		
Input H voltage	V_{IHS}	CMOS hysteresis input pin	—	$0.8 V_{CC}$	—	$V_{CC} + 0.3$	V	
	V_{IH}	TTL input pin	—	2.0	—	—	V	
	V_{IHM}	MD input pin	—	$V_{CC} - 0.3$	—	$V_{CC} + 0.3$	V	
Input L voltage	V_{ILS}	CMOS hysteresis input pin	—	$V_{CC} - 0.3$	—	$0.2 V_{CC}$	V	
	V_{IL}	TTL input pin	—	—	—	0.8	V	
	V_{ILM}	MD input pin	—	$V_{SS} - 0.3$	—	$V_{SS} + 0.3$	V	
Output H voltage	V_{OH}	All output pins	$V_{CC} = 4.5 \text{ V}$, $I_{OH} = -4.0 \text{ mA}$	$V_{CC} - 0.5$	—	—	V	
Output L voltage	V_{OL}	All output pins	$V_{CC} = 4.5 \text{ V}$, $I_{OL} = 4.0 \text{ mA}$	—	—	0.4	V	
Input leak current	I_{IL}	—	$V_{CC} = 5.5 \text{ V}$, $V_{SS} < V_I < V_{CC}$	—5	—	5	μA	
Pull-up resistance	R_{UP}	P00 to P07, P10 to P17, P20 to P27, P30 to P37, RST	—	25	50	100	$\text{k}\Omega$	
Pull-down resistance	R_{DOWN}	MD2	—	25	50	100	$\text{k}\Omega$	Except Flash devices

(Continued)

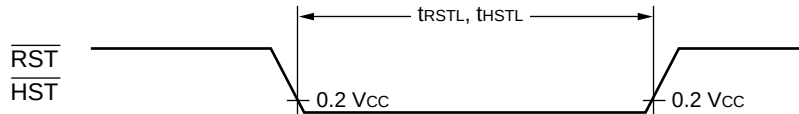
■ **Clock Timing**



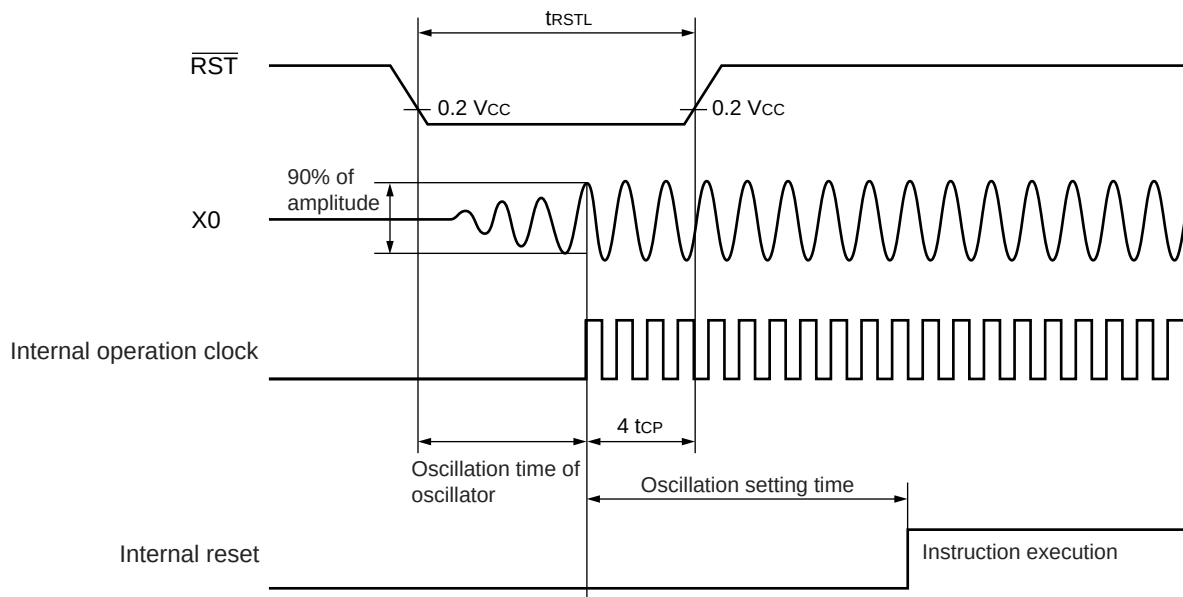
■ **Guaranteed PLL operation range**

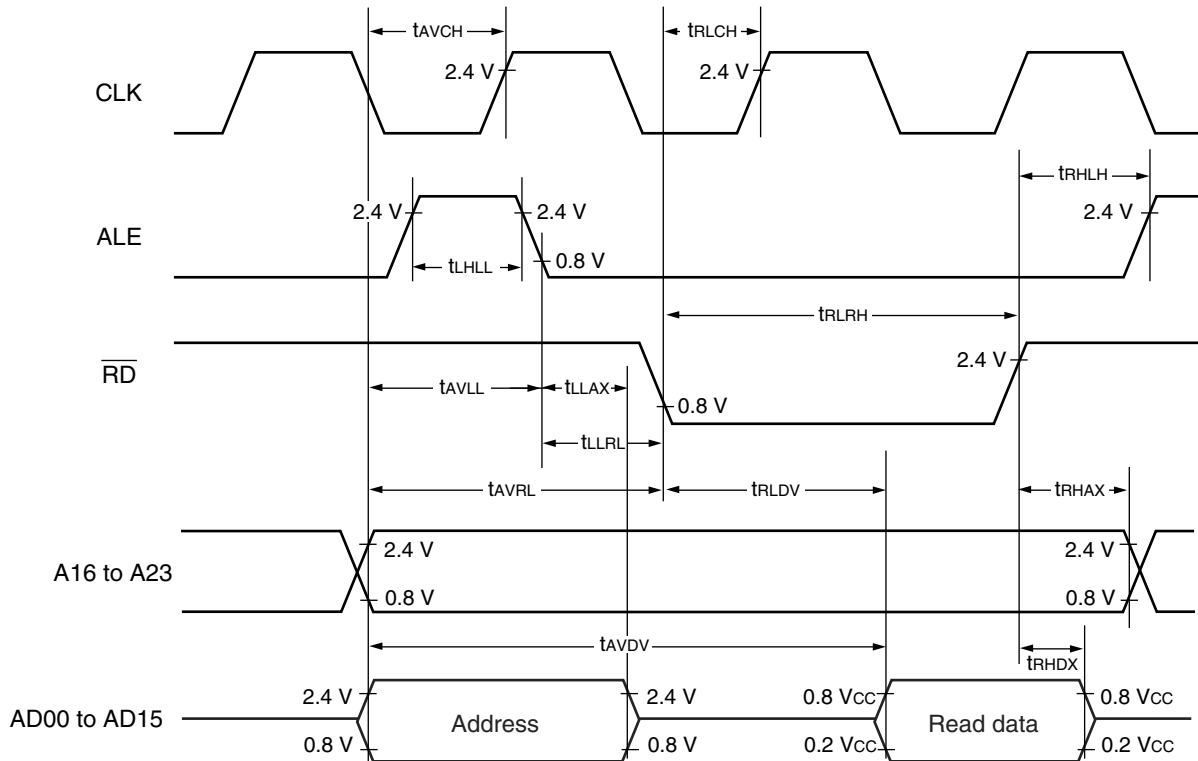


- In under normal operation, pseudo timer mode, sub-clock mode, sub-sleep mode, timer mode



- In stop mode



■ Bus Timing (Read)


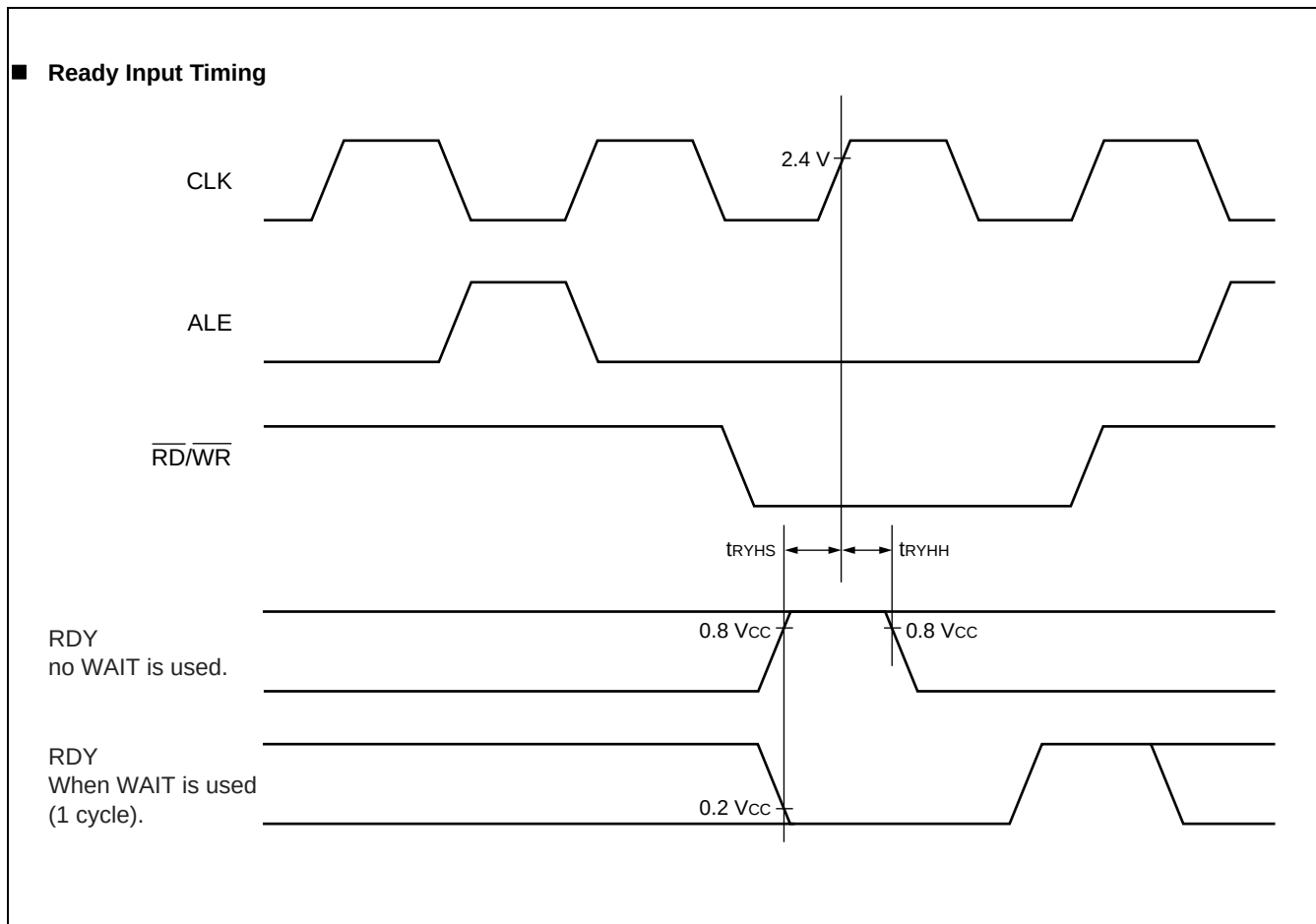
11.4.7 Ready Input Timing

(MB90543G(S)/547G(S)/548G(S)/F548GL(S): $V_{CC} = 3.5 \text{ V to } 5.5 \text{ V}$, $V_{SS} = AV_{SS} = 0.0 \text{ V}$, $T_A = -40^\circ\text{C to } +105^\circ\text{C}$)

(Other than MB90543G(S)/547G(S)/548G(S)/F548GL(S): $V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0.0 \text{ V}$, $T_A = -40^\circ\text{C to } +105^\circ\text{C}$)

Parameter	Symbol	Pin name	Condition	Value		Units	Remarks
				Min	Max		
RDY setup time	t_{RYHS}	RDY	—	45	—	ns	
RDY hold time	t_{RYHH}	RDY	—	0	—	ns	

Note : If the RDY setup time is insufficient, use the auto-ready function.



11.4.8 Hold Timing

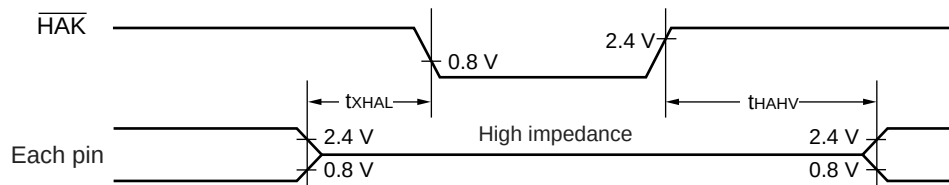
(MB90543G(S)/547G(S)/548G(S)/F548GL(S): $V_{CC} = 3.5 \text{ V to } 5.5 \text{ V}$, $V_{SS} = AV_{SS} = 0.0 \text{ V}$, $T_A = -40^\circ\text{C to } +105^\circ\text{C}$)

(Other than MB90543G(S)/547G(S)/548G(S)/F548GL(S): $V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0.0 \text{ V}$, $T_A = -40^\circ\text{C to } +105^\circ\text{C}$)

Parameter	Symbol	Pin name	Condition	Value		Units	Remarks
				Min	Max		
Pin floating → $\overline{\text{HAK}}\downarrow$ time	t_{XHAL}	$\overline{\text{HAK}}$	—	30	t_{CP}	ns	
$\overline{\text{HAK}}\uparrow$ time → Pin valid time	t_{HAHV}	$\overline{\text{HAK}}$	—	t_{CP}	$2 t_{CP}$	ns	

Note : There is more than 1 cycle from the time HRQ is read to the time the $\overline{\text{HAK}}$ is changed.

■ Hold Timing



11.4.9 UART0/1, Serial I/O Timing

(MB90543G(S)/547G(S)/548G(S)/F548GL(S): $V_{CC} = 3.5 \text{ V to } 5.5 \text{ V}$, $V_{SS} = AV_{SS} = 0.0 \text{ V}$, $T_A = -40^\circ\text{C to } +105^\circ\text{C}$)

(Other than MB90543G(S)/547G(S)/548G(S)/F548GL(S): $V_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0.0 \text{ V}$, $T_A = -40^\circ\text{C to } +105^\circ\text{C}$)

Parameter	Symbol	Pin name	Condition	Value		Units	Remarks
				Min	Max		
Serial clock cycle time	t_{SCYC}	SCK0 to SCK2	Internal clock operation output pins are $C_L = 80 \text{ pF} + 1 \text{ TTL}$.	$8 t_{CP}$	—	ns	
SCK↓ → SOT delay time	t_{SLOV}	SCK0 to SCK2, SOT0 to SOT2		— 80	80	ns	
Valid SIN → SCK↑	t_{VSH}	SCK0 to SCK2, SIN0 to SIN2		100	—	ns	
SCK↑ → Valid SIN hold time	t_{SHIX}	SCK0 to SCK2, SIN0 to SIN2		60	—	ns	
Serial clock "H" pulse width	t_{SHSL}	SCK0 to SCK2	External clock operation output pins are $C_L = 80 \text{ pF} + 1 \text{ TTL}$.	$4 t_{CP}$	—	ns	
Serial clock "L" pulse width	t_{SLSH}	SCK0 to SCK2		$4 t_{CP}$	—	ns	
SCK↓ → SOT delay time	t_{SLOV}	SCK0 to SCK2, SOT0 to SOT2		—	150	ns	
Valid SIN → SCK↑	t_{VSH}	SCK0 to SCK2, SIN0 to SIN2		60	—	ns	
SCK↑ → Valid SIN hold time	t_{SHIX}	SCK0 to SCK2, SIN0 to SIN2		60	—	ns	

Notes :

- AC characteristic in CLK synchronized mode.
- C_L is load capacity value of pins when testing.
- For t_{CP} (Machine clock cycle time) , refer to “ (1) Clock Timing”.

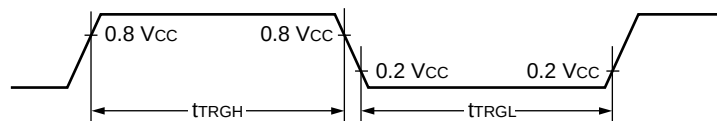
11.4.12 Trigger Input Timing

(MB90543G(S)/547G(S)/548G(S)/F548GL(S): $V_{CC} = 3.5\text{ V to }5.5\text{ V}$, $V_{SS} = AV_{SS} = 0.0\text{ V}$, $T_A = -40\text{ }^{\circ}\text{C to }+105\text{ }^{\circ}\text{C}$)

(Other than MB90543G(S)/547G(S)/548G(S)/F548GL(S): $V_{CC} = 5.0\text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0.0\text{ V}$, $T_A = -40\text{ }^{\circ}\text{C to }+105\text{ }^{\circ}\text{C}$)

Parameter	Symbol	Pin name	Condition	Value		Units	Remarks
				Min	Max		
Input pulse width	t_{TRGH}	INT0 to INT7, ADTG	—	5 t_{CP}	—	ns	Under normal operation
	t_{TRGL}			1	—	μs	In stop mode

■ Trigger Input Timing



11.5 A/D Converter

11.5.1 Electrical Characteristics

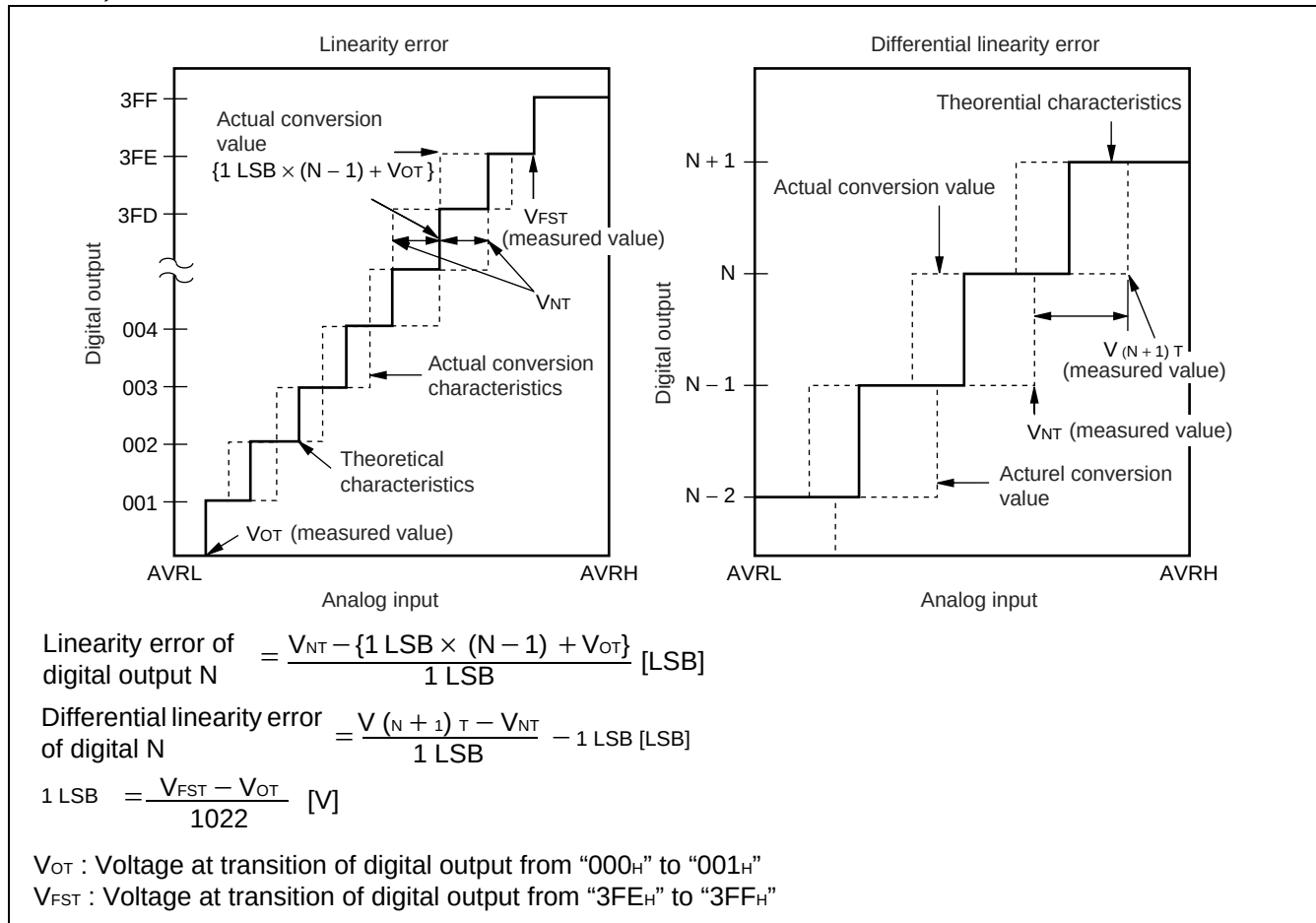
($V_{CC} = AV_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{SS} = AV_{SS} = 0.0 \text{ V}$, $3.0 \text{ V} \leq AV_{RH} - AV_{RL}$, $T_A = -40 \text{ }^\circ\text{C}$ to $+105 \text{ }^\circ\text{C}$)

Parameter	Symbol	Pin name	Value			Units	Remarks
			Min	Typ	Max		
Resolution	—	—	—	—	10	bit	
Conversion error	—	—	—	—	± 5.0	LSB	
Nonlinearity error	—	—	—	—	± 2.5	LSB	
Differential nonlinearity error	—	—	—	—	± 1.9	LSB	
Zero transition voltage	V_{OT}	AN0 to AN7	$AV_{RL} - 3.5 \text{ LSB}$	$AV_{RL} + 0.5 \text{ LSB}$	$AV_{RL} + 4.5 \text{ LSB}$	V	
Full scale transition voltage	V_{FST}	AN0 to AN7	$AV_{RH} - 6.5 \text{ LSB}$	$AV_{RH} - 1.5 \text{ LSB}$	$AV_{RH} + 1.5 \text{ LSB}$	V	
Compare time	—	—	$352 t_{CP}$	—	—	ns	Internal frequency : 16 MHz
Sampling time	—	—	$64 t_{CP}$	—	—	ns	Internal frequency : 16 MHz
Analog port input current	I_{AIN}	AN0 to AN7	-1	—	1	μA	$V_{CC} = AV_{CC} = 5.0 \text{ V} \pm 1\%$
Analog input voltage range	V_{AIN}	AN0 to AN7	AV_{RL}	—	AV_{RH}	V	
Reference voltage range	—	AV_{RH}	$AV_{RL} + 2.7$	—	AV_{CC}	V	
	—	AV_{RL}	0	—	$AV_{RH} - 2.7$	V	
Power supply current	I_A	AV_{CC}	—	5	—	mA	
	I_{AH}	AV_{CC}	—	—	5	μA	*
Reference voltage supply current	I_R	AV_{RH}	—	400	600	μA	Flash device
			—	140	260	μA	MASK ROM
	I_{RH}	AV_{RH}	—	—	5	μA	*
Offset between input channels	—	AN0 to AN7	—	—	4	LSB	

* : When not using an A/D converter, this is the current ($V_{CC} = AV_{CC} = AV_{RH} = 5.0 \text{ V}$) when the CPU is stopped.

Note: The functionality of the A/D converter is only guaranteed for $V_{CC} = 5.0 \text{ V} \pm 10\%$ (also for MB90543G(S)/547G(S)/548G(S)/F548G(S)/F548GL(S)).

(Continued)



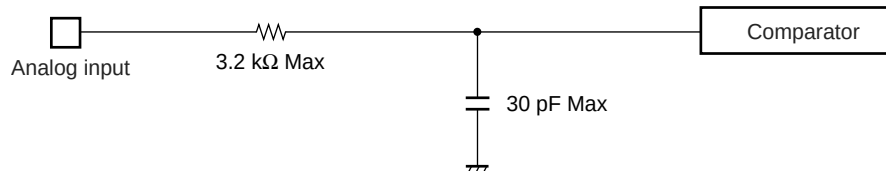
11.5.3 Notes on Using A/D Converter

Select the output impedance value for the external circuit of analog input according to the following conditions, :

- Output impedance values of the external circuit of 15 kΩ or lower are recommended.
- When capacitors are connected to external pins, the capacitance of several thousand times the internal capacitor value is recommended to minimized the effect of voltage distribution between the external capacitor and internal capacitor.

Note : When the output impedance of the external circuit is too high, the sampling period for analog voltages may not be sufficient (sampling period = 4.00 μs @machine clock of 16 MHz) .

■ Equipment of analog input circuit model



11.5.4 Error

The smaller the $|AVRH - AVRL|$, the greater the error would become relatively.

15. Major Changes

Spansion Publication Number: DS07-13703-7E

Section	Change Results
■ PRODUCT LINEUP	Changed the name in peripheral resource. 16-bit I/O Timer → 16-bit Free-run Timer
■ I/O CIRCUIT TYPE	Changed the name of input typ. Hysteresis → CMOS Hysteresis HYS → CMOS Hysteresis
■ BLOCK DIAGRAM	Changed the arrow direction of SOT1 signal at UART1(SCI). “← →” (input/output) → “←” (output)
■ I/O MAP	Changed the text of “Note”.
■ INTERRUPT MAP	Changed the name of peripheral resource of the pin number: #19. I/O Timer → 16-bit Free-run Timer
■ ELECTRICAL CHARACTERISTICS	Changed the remarks of “parameter: Power supply voltage”.
2. Recommended Conditions	
3. DC Characteristics	Changed the maximum value of symbol : VILM of parameter: Input voltage. $V_{CC} + 0.3 \rightarrow V_{SS} + 0.3$ Added the following remarks for parameter : Pull-down resistance. Except Flash device
4. AC Characteristics	Added the value when using an external clock in Oscillation frequency and Clock cycle time on (1) Clock Timing for parameter.
(1) Clock Timing	Added the item of A/D converter operation range in figure of “■ Guaranteed PLL operation range”
(3) Reset and Hardware Standby Input Timing	Changed the following item. (3) Reset and Hardware Standby Input Timing Remarks: In sub-clock mode, sub-sleep mode, timer mode $2t_{CP} \rightarrow 2t_{LCP}$
(4) Power On Reset	Changed as follows; Due to repetitive operation → Waiting time until power-on
5. A/D Converter	Changed the unit of Zero transition voltage and Full scale transition voltage. mV → V
■ ORDERING INFORMATION	Added the MB90F548GLPMC in Part Numbers.

NOTE: Please see “Document History” about later revised information.

Document History

Document Title: MB90F543G(S)/546G(S)/548G(S)/549G(S)/549G(S)/V540G/MB90543G(S)/547G(S)/548G(S)/F548GL(S) CMOS F2MC-16LX MB90540G/545G Series 16-bit Proprietary Microcontroller Document Number: 002-07696				
Revision	ECN	Orig. of Change	Submission Date	Description of Change
**	—	AKIH	11/13/2008	Migrated to Cypress and assigned document number 002-07696. No change to document contents or format.
*A	5537115	AKIH	11/30/2016	Updated to Cypress template